

Three Phase AC Switch (Power Modules), 100 A



MTK

FEATURES

- Package fully compatible with the industry standard INT-A-PAK power modules series
- High thermal conductivity package, electrically insulated case
- Outstanding number of power encapsulated components
- Excellent power volume ratio
- 4000 V_{RMS} isolating voltage
- UL E78996 approved
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRIMARY CHARACTERISTICS	
I_o	100 A
V_{RRM}	800 V to 1600 V
Package	MTK
Circuit configuration	Three phase AC switch

DESCRIPTION

A range of extremely compact, encapsulated three phase AC switches offering efficient and reliable operation. They are intended for use in general purpose and heavy duty applications as control motor starter.

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
I_o		100	A
	T_C	80	°C
I_{FSM}	50 Hz	1130	A
	60 Hz	1180	
I^2t	50 Hz	6380	A ² s
	60 Hz	5830	
$I^2\sqrt{t}$		63 800	A ² √s
V_{RRM}	Range	800 to 1600	V
T_{Stg}	Range	-40 to +125	°C
T_J	Range	-40 to +125	

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS					
TYPE NUMBER	VOLTAGE CODE	V_{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V_{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	V_{DRM} , MAXIMUM REPETITIVE PEAK OFF-STATE VOLTAGE, GATE OPEN CIRCUIT V	I_{RRM}/I_{DRM} , MAXIMUM AT $T_J = 125^\circ\text{C}$ mA
VS-104MT..K	80	800	900	800	40 ⁽¹⁾
	100	1000	1100	1000	
	120	1200	1300	1200	
	140	1400	1500	1400	
	160	1600	1700	1600	

Note

⁽¹⁾ For single AC switch



FORWARD CONDUCTION					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum I _{RMS} output current at case temperature	I _O	For all conduction angle		100	A
				80	°C
Maximum peak, one-cycle forward, non-repetitive on state surge current	I _{TSM}	t = 10 ms	No voltage reapplied	1130	A
		t = 8.3 ms			
		t = 10 ms	100 % V _{RRM} reapplied	950	
		t = 8.3 ms			
Maximum I ² t for fusing	I ² t	t = 10 ms	No voltage reapplied	6380	A ² s
		t = 8.3 ms			
		t = 10 ms	100 % V _{RRM} reapplied	4510	
		t = 8.3 ms			
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to 10 ms, no voltage reapplied		63 800	A ² √s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % × π × I _{T(AV)} < I < π × I _{T(AV)}), T _J maximum		0.99	V
High level value of threshold voltage	V _{T(TO)2}	(I > π × I _{T(AV)}), T _J maximum		1.15	
Low level value on-state slope resistance	r _{t1}	16.7 % × π × I _{T(AV)} < I < π × I _{T(AV)} , T _J maximum		3.90	mΩ
High level value on-state slope resistance	r _{t2}	(I > π × I _{T(AV)}), T _J maximum		3.48	
Maximum on-state voltage drop	V _{TM}	I _{pk} = 150 A, T _J = 25 °C, t _p = 400 μs single junction		1.53	V
Maximum non-repetitive rate of rise of turned on current	dI/dt	T _J = 25 °C, from 0.67 V _{DRM} , I _{TM} = π × I _{T(AV)} , I _g = 500 mA, t _r < 0.5 μs, t _p > 6 μs		150	A/μs
Maximum holding current	I _H	T _J = 25 °C, anode supply = 6 V, resistive load, gate open circuit		200	mA
Maximum latching current	I _L	T _J = 25 °C, anode supply = 6 V, resistive load		400	

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
RMS isolation voltage	V _{INS}	T _J = 25 °C all terminal shorted f = 50 Hz, t = 1 s		4000	V
Maximum critical rate of rise of off-state voltage	dV/dt (1)	T _J = T _J maximum, linear to 0.67 V _{DRM} , gate open circuit		500	V/μs

Note

(1) Available with dV/dt = 1000 V/μs, to complete code add S90 i. e. 104MT160KBS90

TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum peak gate power	P _{GM}	T _J = T _J maximum		10	W
Maximum average gate power	P _{G(AV)}			2.5	
Maximum peak gate current	I _{GM}			2.5	A
Maximum peak negative gate voltage	-V _{GT}			10	V
Maximum required DC gate voltage to trigger	V _{GT}	T _J = 40 °C	4.0		
		T _J = 25 °C	2.5		
		T _J = 125 °C	1.7		
Maximum required DC gate current to trigger	I _{GT}	T _J = -40 °C	270	mA	
		T _J = 25 °C	150		
		T _J = 125 °C	80		
Maximum gate voltage that will not trigger	V _{GD}	T _J = T _J maximum, rated V _{DRM} applied		0.25	V
Maximum gate current that will not trigger	I _{GD}			6	mA

THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction operating and storage temperature range	T_J, T_{Stg}		-40 to +125	°C
Maximum thermal resistance, junction to case	R_{thJC}	DC operation per single AC switch	0.34	K/W
		DC operation per junction	0.69	
		180 °C sine conduction angle per single AC switch	0.36	
		180 °C sine conduction angle per junction	0.72	
Maximum thermal resistance, case to heat sink	R_{thCS}	Per module Mounting surface smooth, flat and greased	0.03	
Mounting torque $\pm 100\%$	to heat sink to terminal	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads.	4 to 6	Nm
			3 to 4	
Approximate weight			225	g

ΔR CONDUCTION PER JUNCTION											
DEVICES	SINUSOIDAL CONDUCTION AT T_J MAXIMUM					RECTANGULAR CONDUCTION AT T_J MAXIMUM					UNITS
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
104MT.K	0.027	0.033	0.042	0.057	0.081	0.023	0.037	0.046	0.059	0.082	K/W

Note

- Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

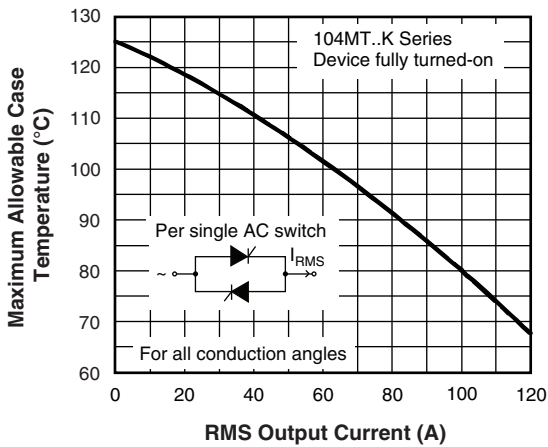


Fig. 1 - Current Ratings Characteristic

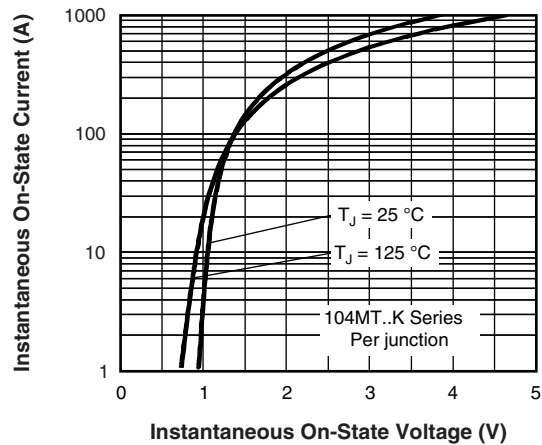


Fig. 2 - Forward Voltage Drop Characteristics

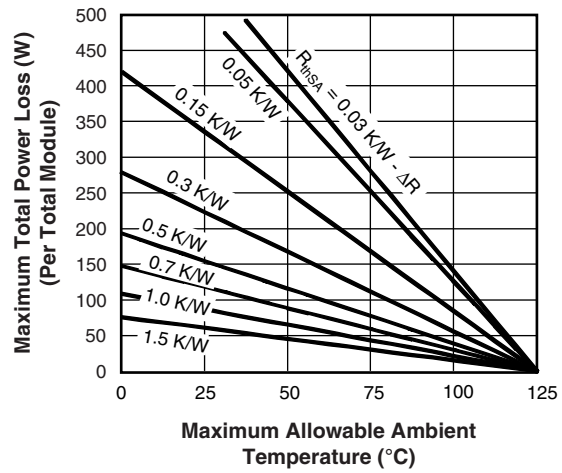
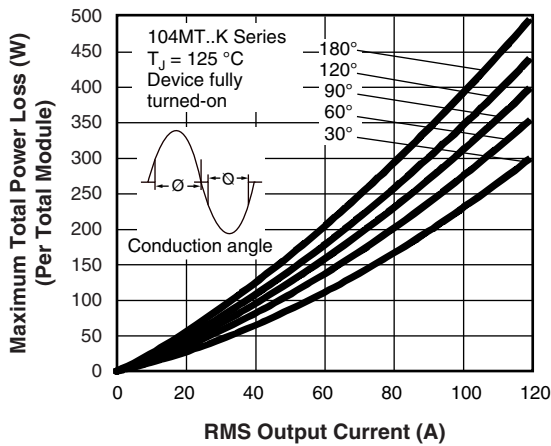


Fig. 3 - Total Power Loss Characteristics

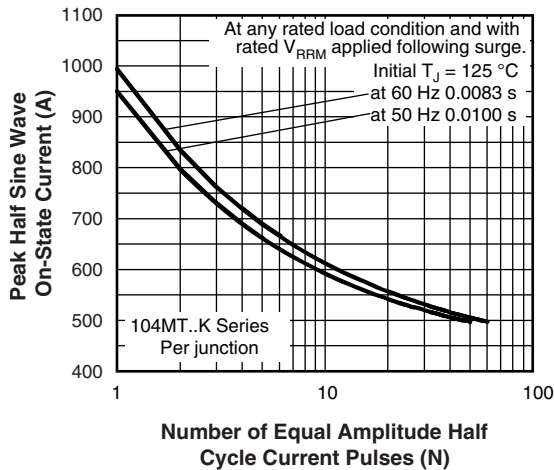


Fig. 4 - Maximum Non-Repetitive Surge Current

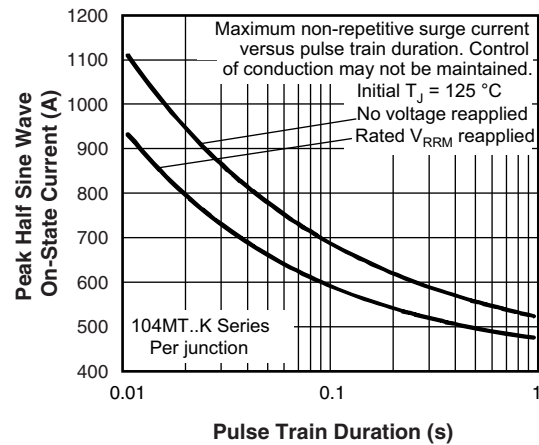


Fig. 5 - Maximum Non-Repetitive Surge Current

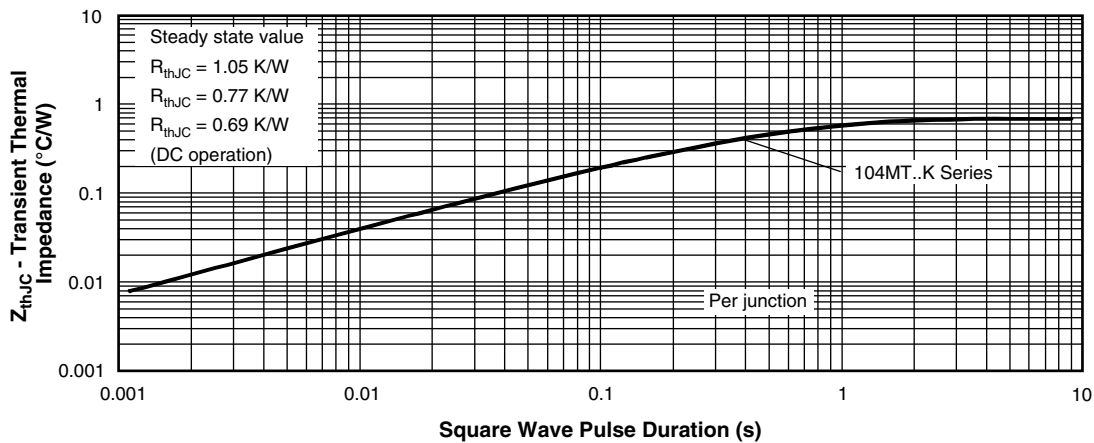


Fig. 6 - Thermal Impedance Z_{thJC} Characteristics

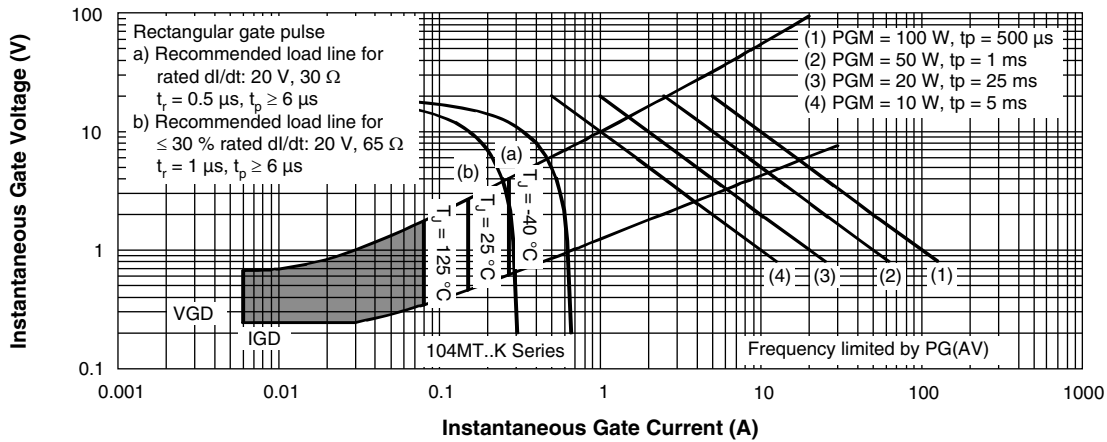


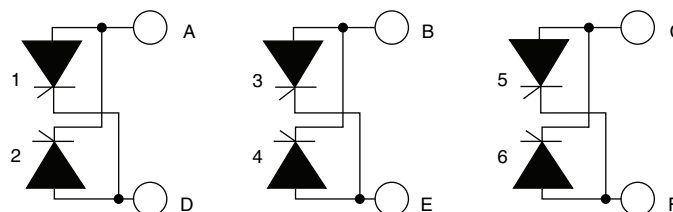
Fig. 7 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code	VS-	10	4	MT	160	K	PbF
	(1)	(2)	(3)	(4)	(5)	(6)	(6)
	1	-	Vishay Semiconductors product				
	2	-	Current rating code: 10 = 100 A (average)				
	3	-	AC switch				
	4	-	Essential part number				
	5	-	Voltage code x 10 = V_{RRM} (see Voltage Ratings table)				
	6	-	PbF = lead (Pb)-free				

Note

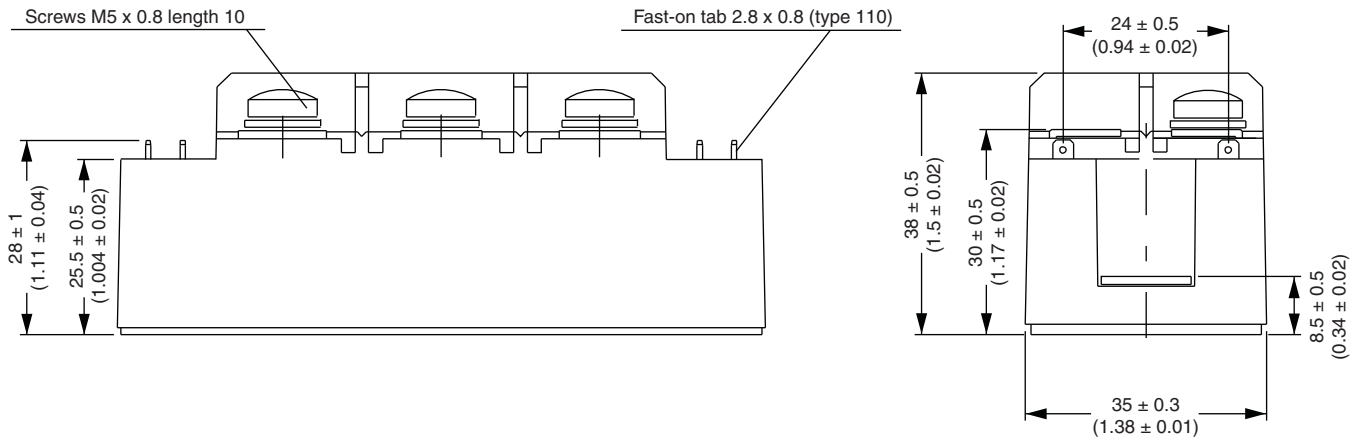
- To order the optional hardware go to www.vishay.com/doc?95172

CIRCUIT CONFIGURATION

LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95004
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MTK (with and without optional barrier)

DIMENSIONS WITH OPTIONAL BARRIERS in millimeters (inches)



Outline Dimensions

Vishay Semiconductors MTK (with and without optional barrier)



DIMENSIONS WITHOUT OPTIONAL BARRIERS in millimeters (inches)





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